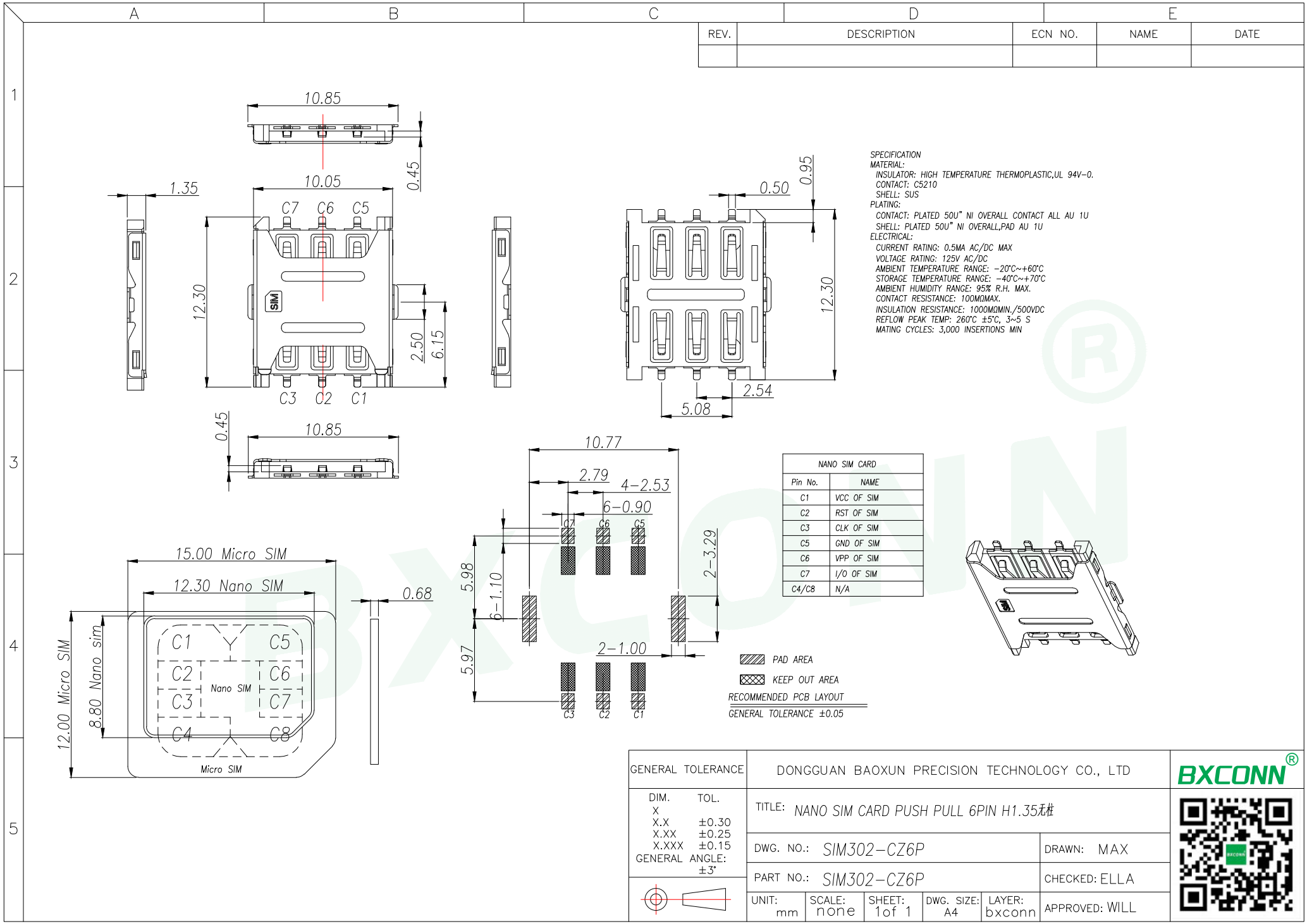




REV.	DESCRIPTION	ECN NO.	NAME	DATE

SPECIFICATION
MATERIAL:
INSULATOR: HIGH TEMPERATURE THERMOPLASTIC,UL 94V-0.
CONTACT: C5210
SHELL: SUS
PLATING:
CONTACT: PLATED 50U" NI OVERALL CONTACT ALL AU 1U
SHELL: PLATED 50U" NI OVERALL,PAD AU 1U
ELECTRICAL:
CURRENT RATING: 0.5MA AC/DC MAX
VOLTAGE RATING: 125V AC/DC
AMBIENT TEMPERATURE RANGE: -20°C~+60°C
STORAGE TEMPERATURE RANGE: -40°C~+70°C
AMBIENT HUMIDITY RANGE: 95% R.H. MAX.
CONTACT RESISTANCE: 100MOMAX.
INSULATION RESISTANCE: 1000MOMIN./500VDC
REFLOW PEAK TEMP: 260°C ±5°C, 3~5 S
MATING CYCLES: 3,000 INSERTIONS MIN

NANO SIM CARD	
Pin No.	NAME
C1	VCC OF SIM
C2	RST OF SIM
C3	CLK OF SIM
C5	GND OF SIM
C6	VPP OF SIM
C7	I/O OF SIM
C4/C8	N/A

PAD AREA
KEEP OUT AREA
RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

GENERAL TOLERANCE		DONGGUAN BAOXUN PRECISION TECHNOLOGY CO., LTD							
DIM. TOL. X X.X ±0.30 X.XX ±0.25 X.XXX ±0.15 GENERAL ANGLE: ±3°		TITLE: NANO SIM CARD PUSH PULL 6PIN H1.35无#							
		DWG. NO.: SIM302-CZ6P			DRAWN: MAX				
		PART NO.: SIM302-CZ6P			CHECKED: ELLA				
		UNIT: mm			SCALE: none	SHEET: 1 of 1			DWG. SIZE: A4